

CHAPTER 18:

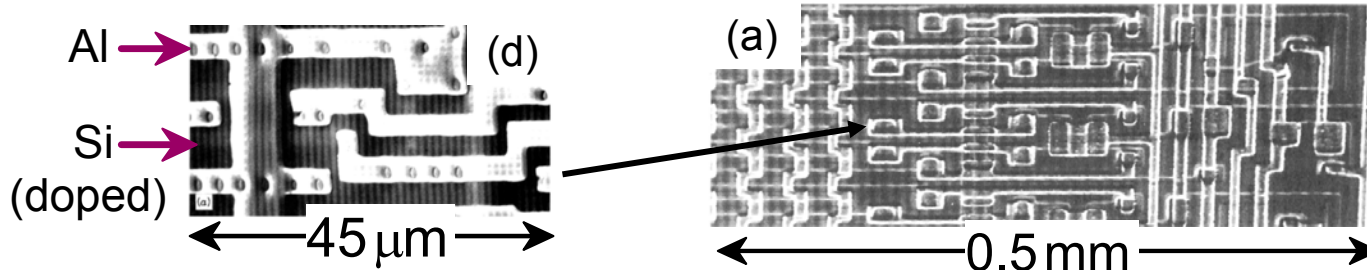
Electrical properties

ISSUES TO ADDRESS...

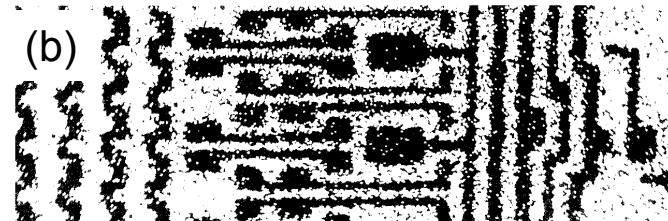
- How are electrical conductance and resistance characterized?
- What are the physical phenomena that distinguish conductors, semiconductors, and insulators?
- For metals, how is conductivity affected by imperfections, T , and deformation?
- For semiconductors, how is conductivity affected by impurities (doping) and T ?

View of an integrated circuit

- Scanning electron microscope images of an IC:



- A dot map showing location of Si (a semiconductor):
--Si shows up as light regions.



- A dot map showing location of Al (a conductor):
--Al shows up as light regions.

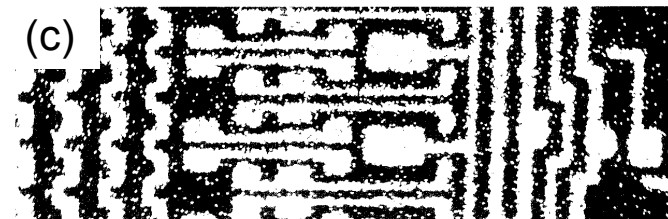
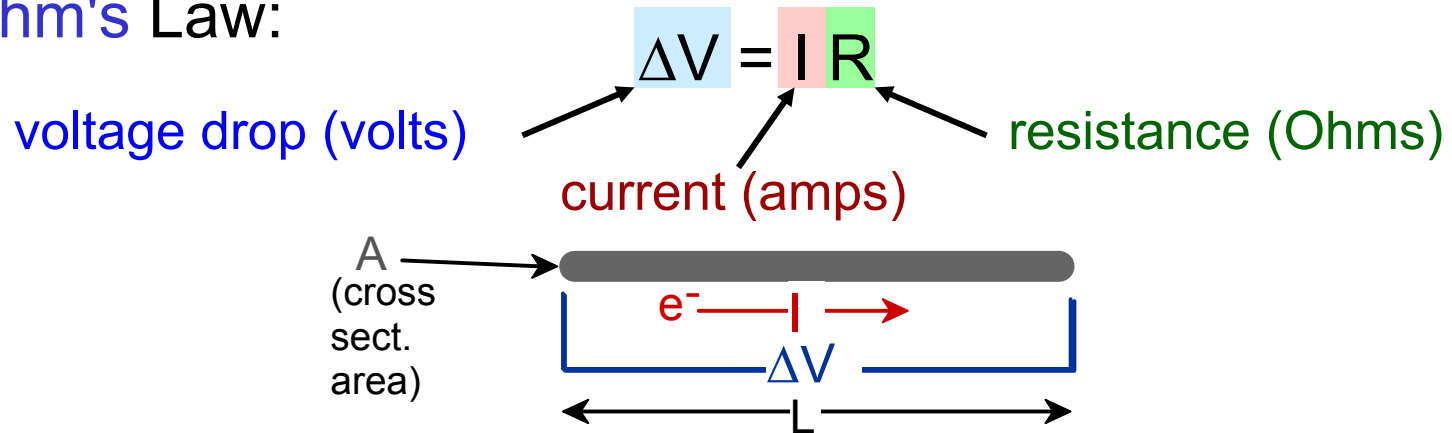


Fig. (d) from Fig. 18.25, *Callister 6e*. (Fig. 18.25 is courtesy Nick Gonzales, National Semiconductor Corp., West Jordan, UT.)

Fig. (a), (b), (c) from Fig. 18.0, *Callister 6e*.

Electrical conduction

- Ohm's Law:



- Resistivity, ρ and Conductivity, σ :
--geometry-independent forms of Ohm's Law

Diagram illustrating the relationship between electric field intensity, current density, resistivity, and conductivity:

$$\frac{\Delta V}{L} = \frac{I}{A} \rho$$

Labels for the equation:

- $\frac{\Delta V}{L}$: E: electric field intensity
- $\frac{I}{A}$: J: current density
- ρ : resistivity (Ohm-m)

Conductivity σ is defined as:

$$\sigma = \frac{1}{\rho}$$

- Resistance: $R = \frac{\rho L}{A} = \frac{L}{A \sigma}$

Conductivity: comparison

- Room T values (Ohm-m) ⁻¹

METALS

conductors

Silver 6.8×10^7

Copper 6.0×10^7

Iron 1.0×10^7

CERAMICS

Soda-lime glass 10^{-10}

Concrete 10^{-9}

Aluminum oxide $<10^{-13}$

SEMICONDUCTORS

Silicon 4×10^{-4}

Germanium 2×10^0

GaAs 10^{-6}

semiconductors

POLYMERS

Polystyrene $<10^{-14}$

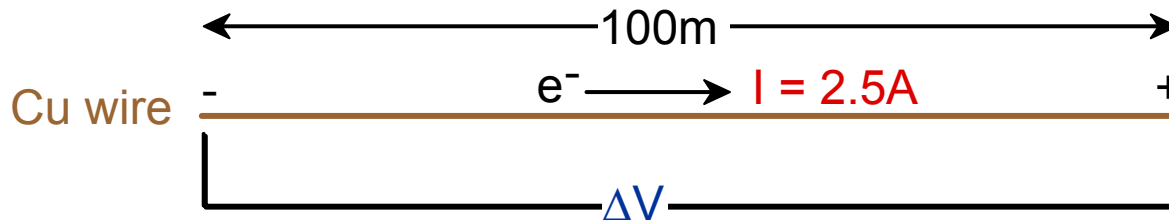
Polyethylene 10^{-15} - 10^{-17}

insulators

Selected values from Tables 18.1, 18.2, and 18.3, *Callister 6e*.

Ex: Conductivity problem

- Question 18.2, p. 649, *Callister 6e*:



What is the minimum diameter (D) of the wire so that $\Delta V < 1.5V$?

$$R = \frac{L}{A\sigma} = \frac{\Delta V}{I}$$

Diagram illustrating the variables in the resistance formula:

- L (length) is 100m.
- A (cross-sectional area) is $\frac{\pi D^2}{4}$.
- σ (conductivity) is $6.07 \times 10^7 \text{ (Ohm-m)}^{-1}$.
- ΔV (voltage drop) is $< 1.5V$.
- I (current) is 2.5A.

Solve to get $D > 1.88 \text{ mm}$

Electron mobility

Under acceleration from external electric field

- Average distance traveled by electrons = *mean free path*, *d*. The *drift velocity*, v_e is the average speed of the electrons.

$$v_d = d/t$$

The *mobility* is defined as

$$\mu_e = v_d/E \text{ (expressed in m}^2/\text{V.s)}$$

Conductivity expression

In general, for an electronic carrier

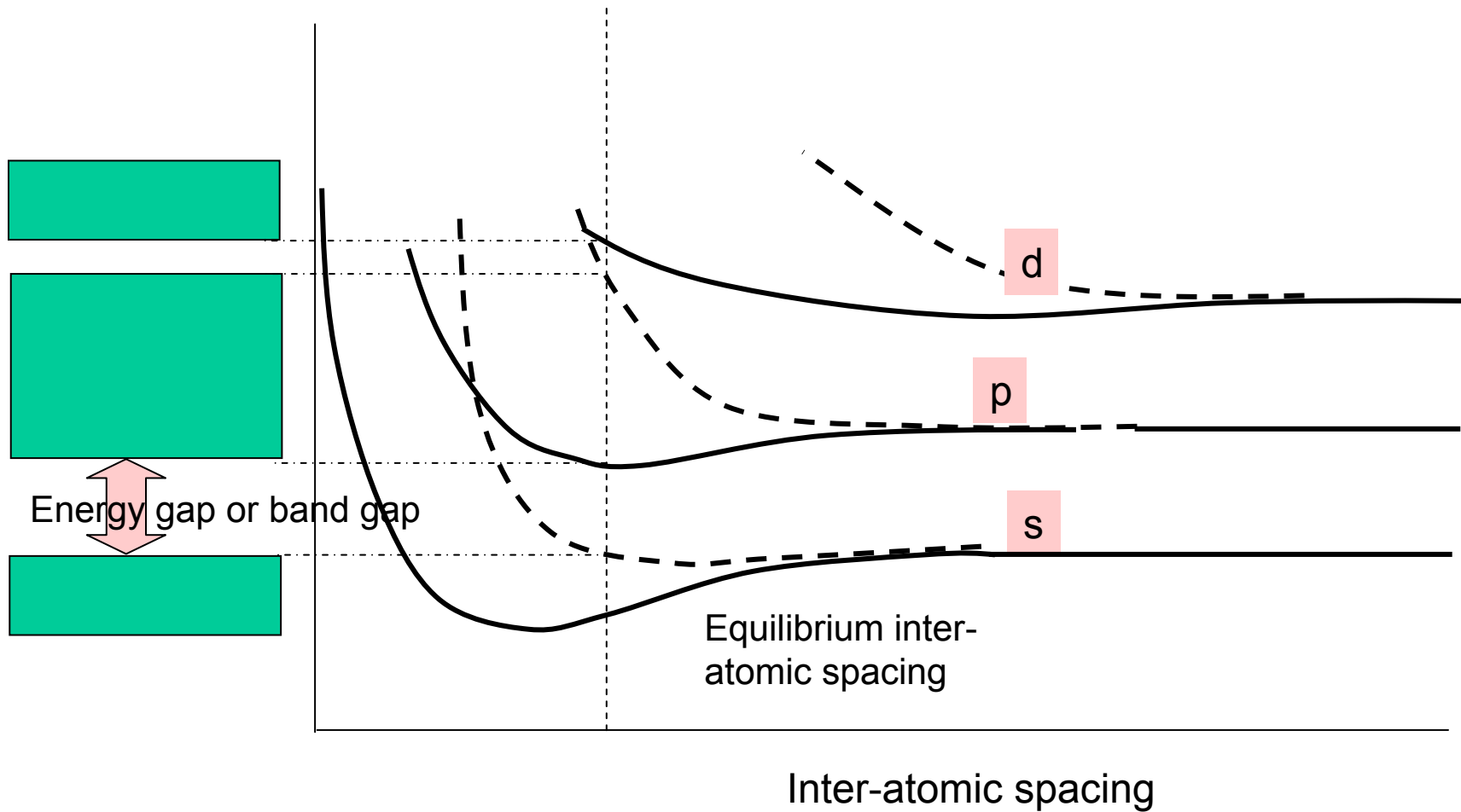
$$\sigma = n e \mu_e$$

n , the number of carriers per unit volume, or density of carriers (#carriers/m³).

e , the electron charge, (1.6x10⁻¹⁹ Coulombs)

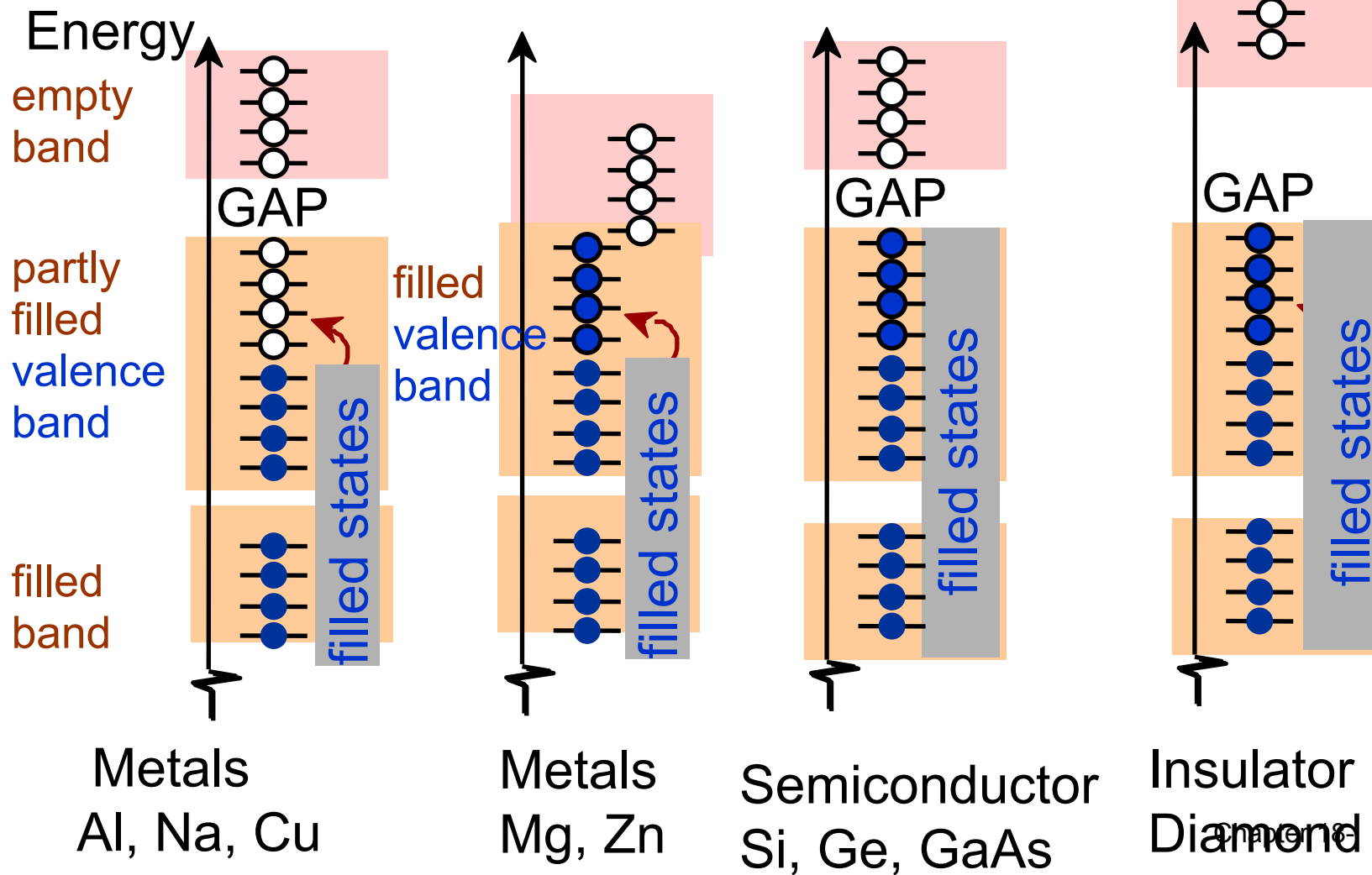
μ_e , the electron mobility, (m²/V.s)

Energy Band model



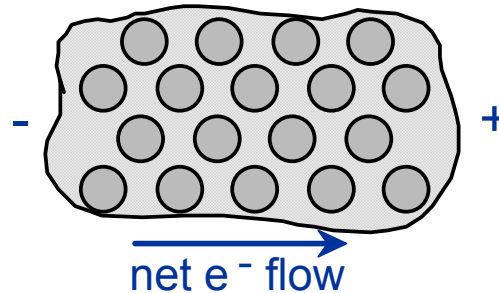
Energy band structures

Valence and Conduction bands



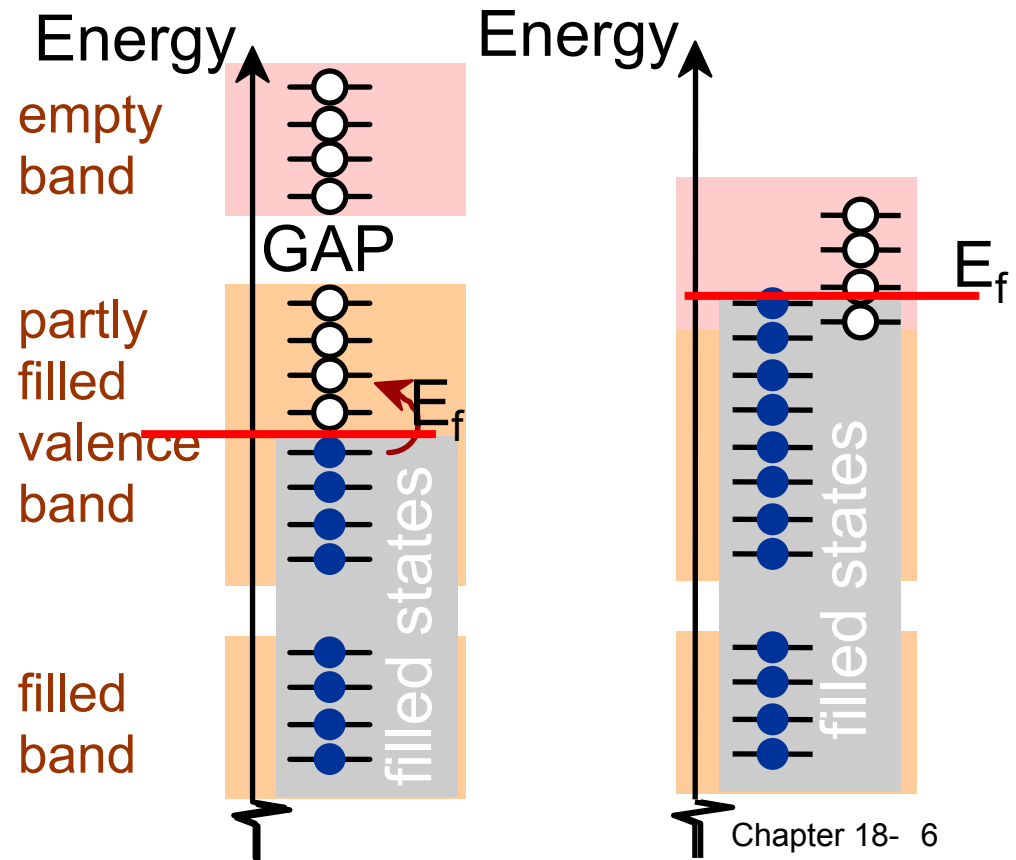
Conduction & electron transport

- Metals:
 - Thermal energy puts many electrons into a higher energy state.



- Energy States:
 - the cases below for metals show that nearby energy states are accessible by thermal fluctuations.

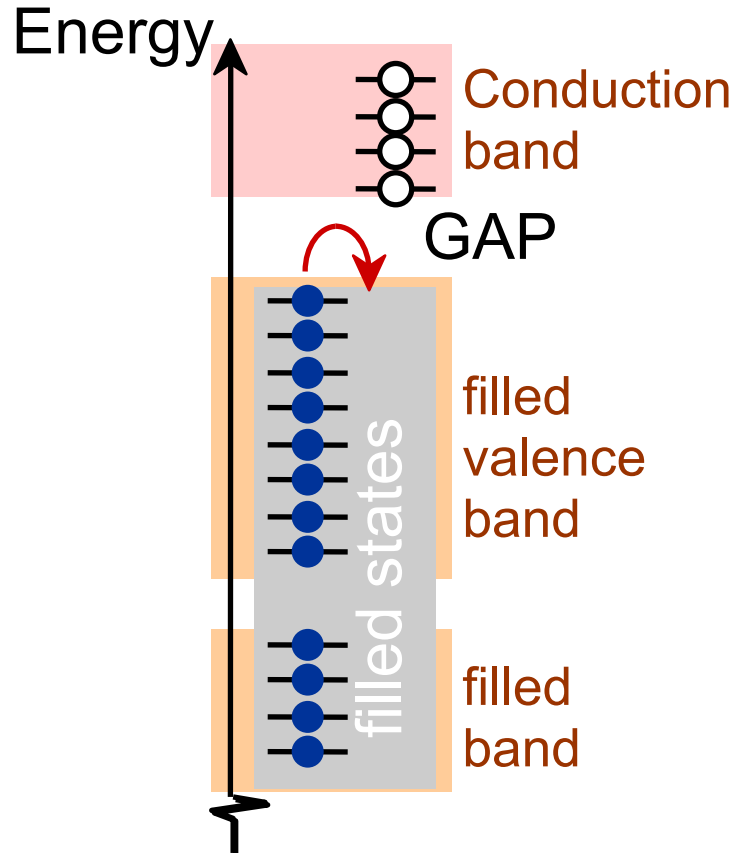
Fermi energy = energy corresponding to top most filled state at 0K



Energy states: insulators and semiconductors

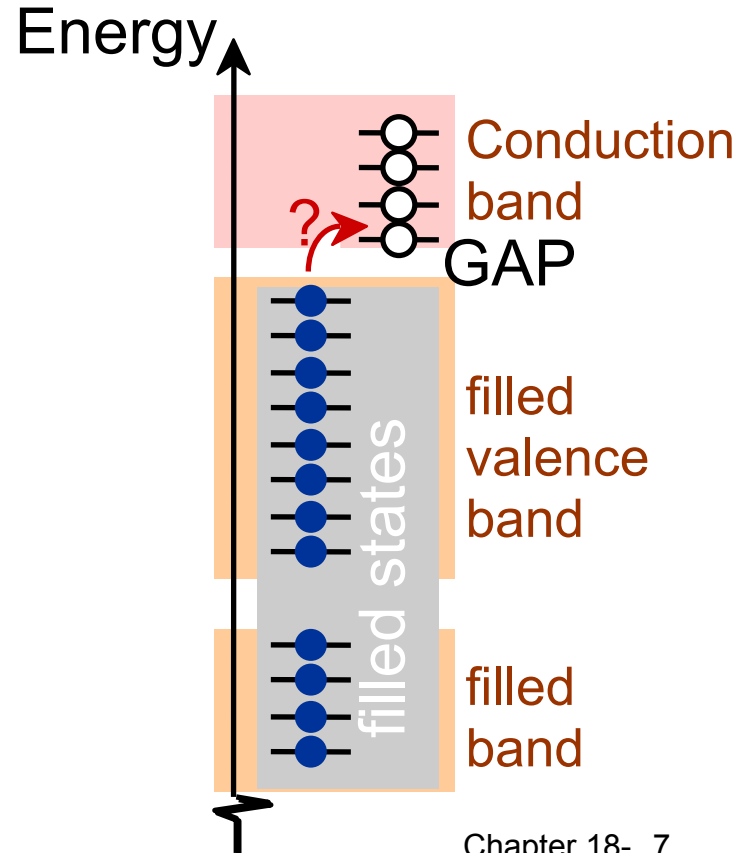
- Insulators:

- Higher energy states not accessible due to gap.



- Semiconductors:

- Higher energy states separated by a smaller gap.

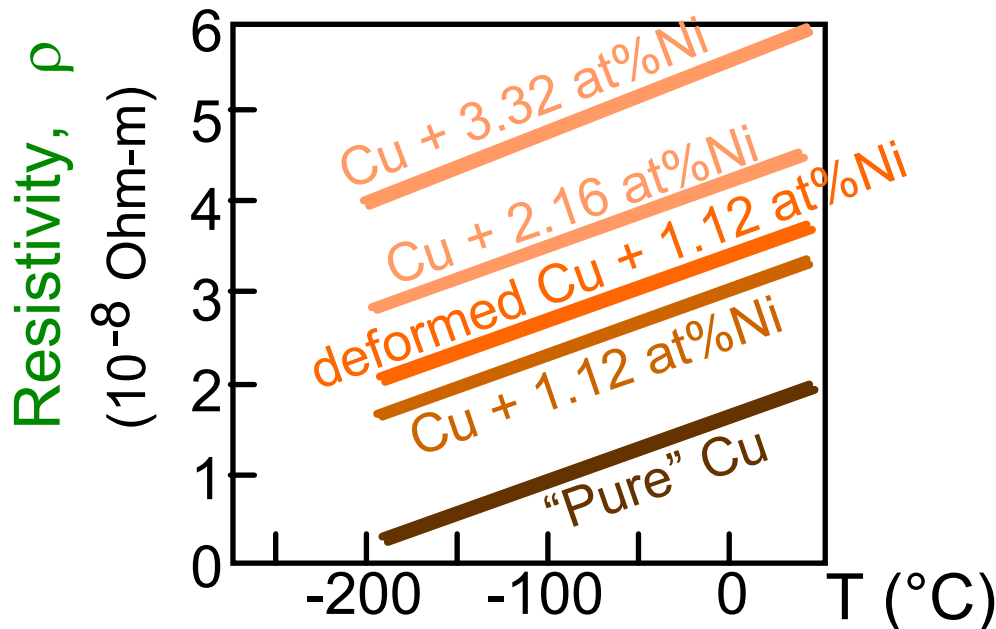


Metals: resistivity vs T, impurities

- Imperfections increase resistivity

- grain boundaries
- dislocations
- impurity atoms
- vacancies

These act to scatter electrons so that they take a less direct path.



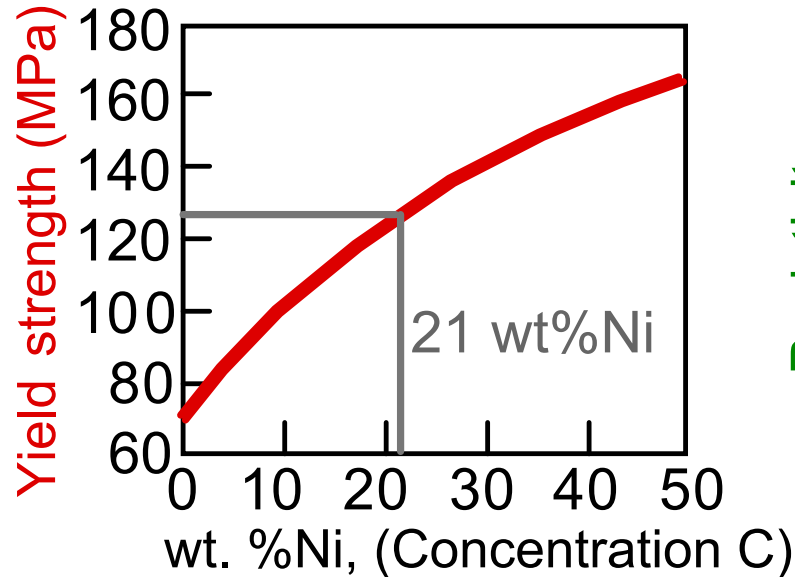
- Resistivity increases with:
 - temperature
 - wt% impurity
 - %CW

$$\rho = \rho_{\text{thermal}} + \rho_{\text{thermal}} + \rho_{\text{def}}$$

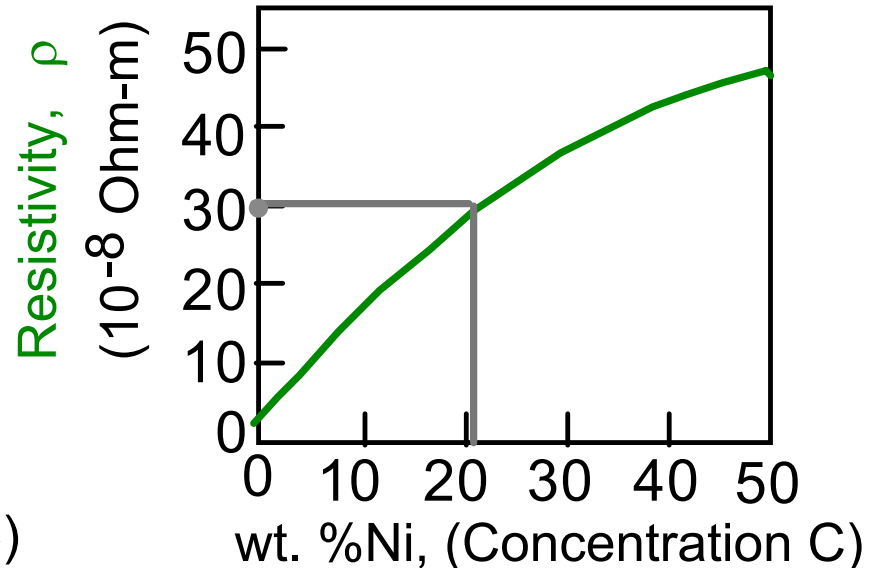
Adapted from Fig. 18.8, *Callister 6e*. (Fig. 18.8 adapted from J.O. Linde, *Ann. Physik* **5**, p. 219 (1932); and C.A. Wert and R.M. Thomson, *Physics of Solids*, 2nd ed., McGraw-Hill Book Company, New York, 1970.)

Ex: Estimating conductivity

- Question:
 - Estimate the electrical conductivity of a Cu-Ni alloy that has a yield strength of 125MPa.



Adapted from Fig. 7.14(b), Callister 6e.



Adapted from Fig. 18.9, Callister 6e.

$$\rho = 30 \times 10^{-8} \text{ Ohm} - \text{m}$$

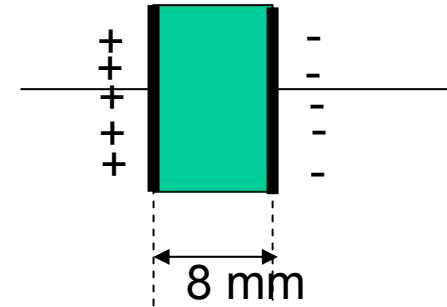
$$\sigma = \frac{1}{\rho} = 3.3 \times 10^6 (\text{Ohm} - \text{m})^{-1}$$

Energies

Electrical energy

Voltage gradient or electric field
 1.25×10^6 volts/cm \sim 2.5 eV

1 millions Volts!



Thermal energy

Average thermal energy = kT
At RT (~ 300 K) = $0.86 \times 300 = 0.026$ eV
At 2000 C, kT = measily 0.2 eV

Light energy

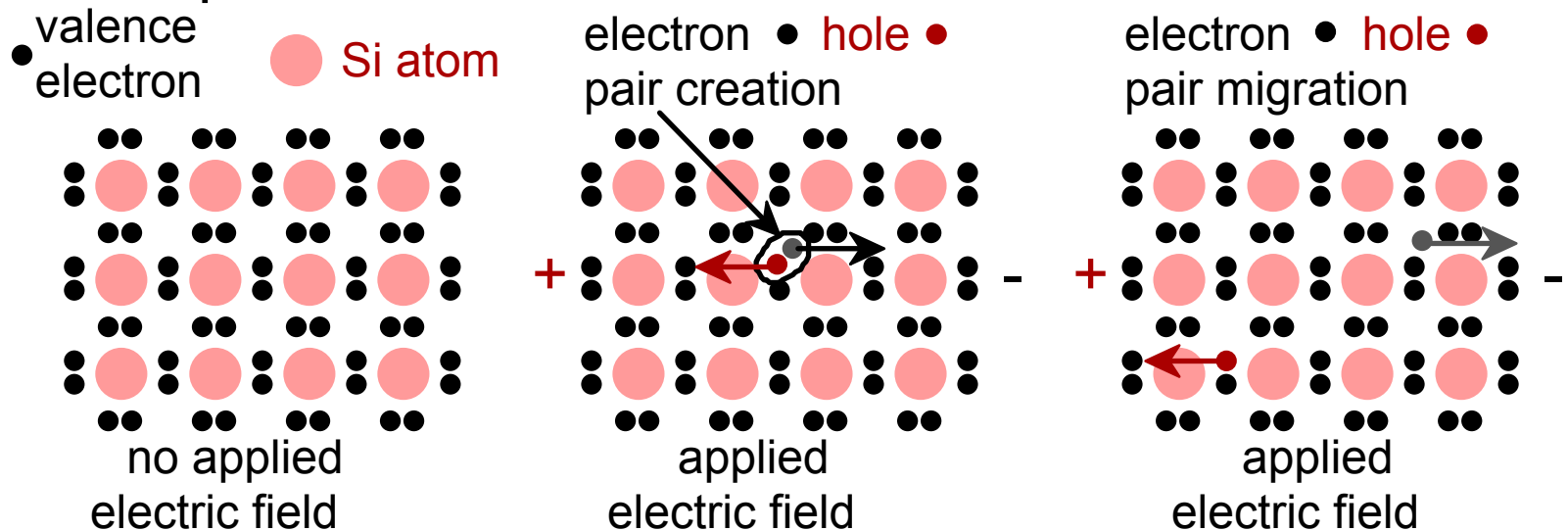
Visible light photon energy quanta whooping 1.7 to 3.1 eV!

Shining light of a given wavelength on a crystal transfer more electrons across the gap than through thermal excitation or electric field!!!

Obviously Light carries lots of energy!!!!

Conduction in terms of electron and hole migration

- Concept of electrons and holes:



Adapted from Fig. 18.10,
Callister 6e.

- Electrical Conductivity given by:

$$\sigma = \underset{\substack{\uparrow \\ \text{\# electrons/m}^3}}{n} |e| \underset{\substack{\uparrow \\ \text{electron mobility}}}{\mu_e} + \underset{\substack{\uparrow \\ \text{\# holes/m}^3}}{p} |e| \underset{\substack{\uparrow \\ \text{hole mobility}}}{\mu_h}$$

Intrinsic vs extrinsic conduction

- Intrinsic:**

electrons = # holes ($n = p$)

--case for pure Si

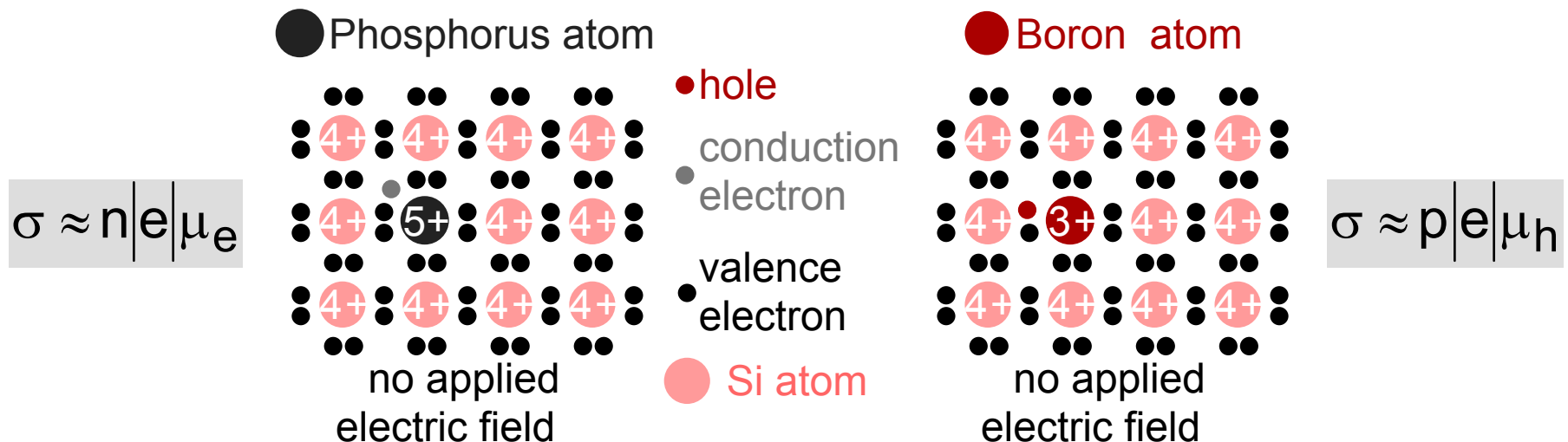
- Extrinsic:**

-- $n \neq p$

--occurs when impurities are added with a different # valence electrons than the host (e.g., Si atoms)

- N-type** Extrinsic: ($n \gg p$)

- P-type** Extrinsic: ($p \gg n$)



Examples of elemental and compound semiconductors

Si
Ge – Group IV
Sn

													column					
Ge – Group IV Sn																		
IA	IIA												IIIA		IVA	VIA	VIIA	0
H	Li	Be											B	C	N	O	F	He
													2.0	5.5	3.0		4.0	-
Na	Mg													13	15	16	17	18
		IIIB	IVB	VB	VIB	VIIIB	VIII			IB	IIIB		Al	Si	P	S	Cl	Ar
													1.5	1.1	2.1	2.5		-
K	Ca	21 Sc	Ti	23 V	Cr	25 Mn	Fe	27 Co	Ni	29 Cu	Zn	Ga	Ge	As	34 Se	Br	Kr	
		1.3		1.6		1.5		1.8		1.9			0.7		2.4		-	
Rb	Sr	39 Y	40 Zr	41 Nb	42 Mo	43 Tc	44 Ru	45 Rh	46 Pd	47 Ag	48 Cd	49 In	50 Sn	51 Sb	52 Te	I	Xe	
		1.2	1.4	1.6	1.8	1.9	2.2	2.2	2.2	1.9	1.7	1.7	0.1	1.9	2.1		-	
Cs	Ba	57-71 La-Lu	72 Hf	73 Ta	74 W	75 Re	76 Os	77 Ir	78 Pt	79 Au	80 Hg	81 Tl	Pb	83 Bi	84 Po	At	Rn	
		1.1-1.2	1.3	1.5	1.7	1.9	2.2	2.2	2.2	2.4	1.9	1.8		1.9	2.6		-	
Fr	Ra	89-100 Ac-No																
		1.1-1.7																
																		GaAs

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material	band gap (eV)
Si	1.11
Ge	0.67
GaP	2.25
CdS	2.40

ZnSe
CdTe – Group II-VI
HgTe

GaAs
GaP – Group III-V
CdS

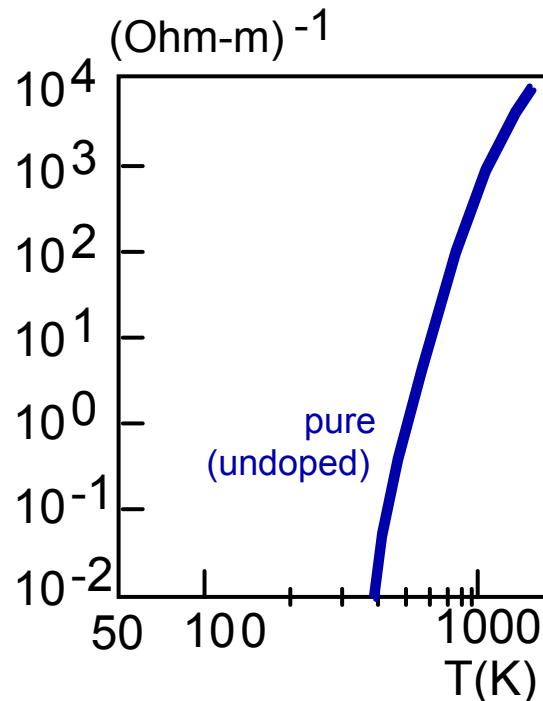
Pure semiconductors: conductivity vs T

- Data for **Pure Silicon**:

- σ increases with T

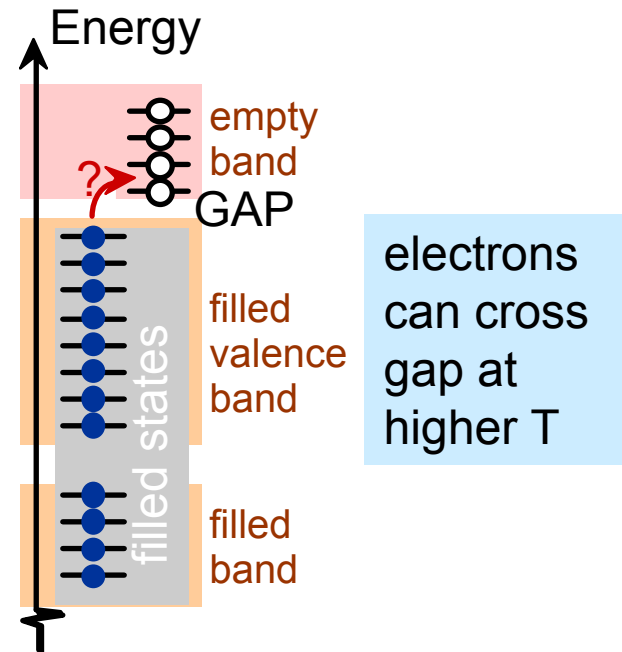
- opposite to metals

electrical conductivity, σ



Adapted from Fig. 19.15, *Callister 5e*. (Fig. 19.15 adapted from G.L. Pearson and J. Bardeen, *Phys. Rev.* **75**, p. 865, 1949.)

$$\sigma_{\text{undoped}} \propto e^{-E_{\text{gap}} / 2k_B T}$$

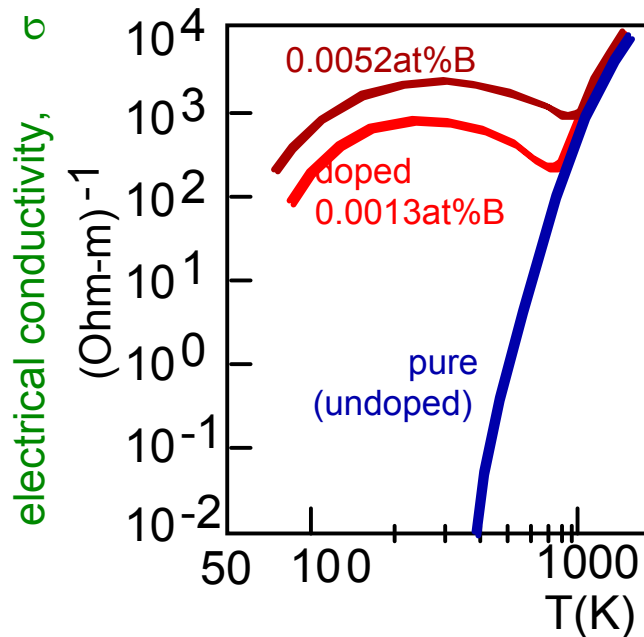


material	band gap (eV)
Si	1.11
Ge	0.67
GaP	2.25
CdS	2.40

Selected values from Table 18.2, *Callister 6e*.

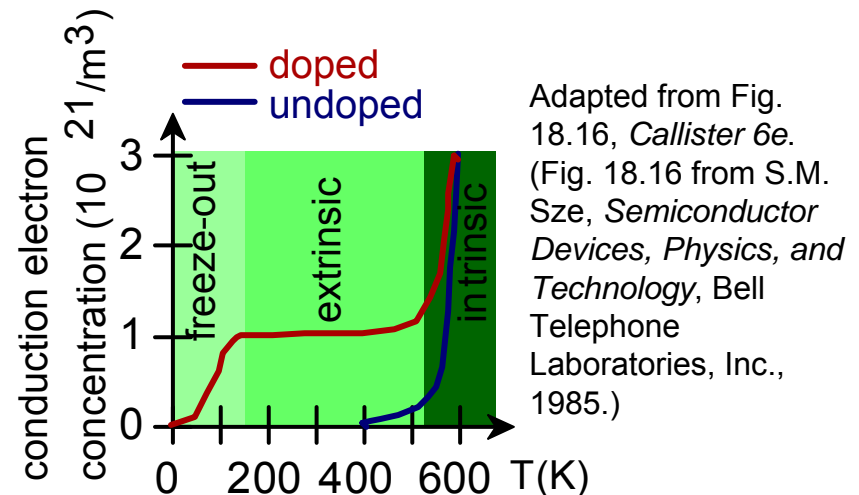
doped semicon: conductivity vs T

- Data for **Doped Silicon**:
 - σ increases doping
 - reason: imperfection sites lower the activation energy to produce mobile electrons.



Adapted from Fig. 19.15, *Callister 5e*. (Fig. 19.15 adapted from G.L. Pearson and J. Bardeen, *Phys. Rev.* **75**, p. 865, 1949.)

- Comparison: **intrinsic** vs **extrinsic** conduction...
 - extrinsic doping level: $10^{21}/\text{m}^3$ of a n-type donor impurity (such as P).
 - for $T < 100\text{K}$: "freeze-out" thermal energy insufficient to excite electrons.
 - for $150\text{K} < T < 450\text{K}$: "extrinsic"
 - for $T \gg 450\text{K}$: "intrinsic"

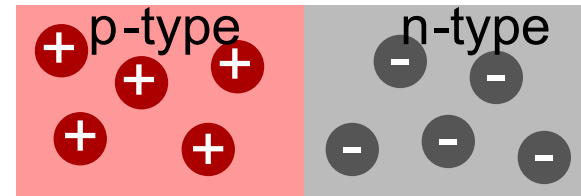


Adapted from Fig. 18.16, *Callister 6e*. (Fig. 18.16 from S.M. Sze, *Semiconductor Devices, Physics, and Technology*, Bell Telephone Laboratories, Inc., 1985.)

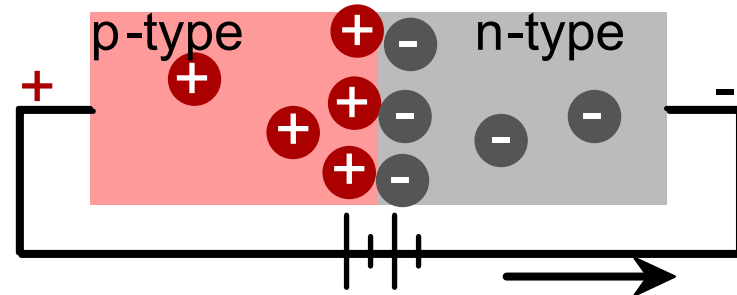
P-N rectifying junction

- Allows flow of electrons in one direction only (e.g., useful to convert alternating current to direct current).
- Processing: diffuse P into one side of a B-doped crystal.
- Results:

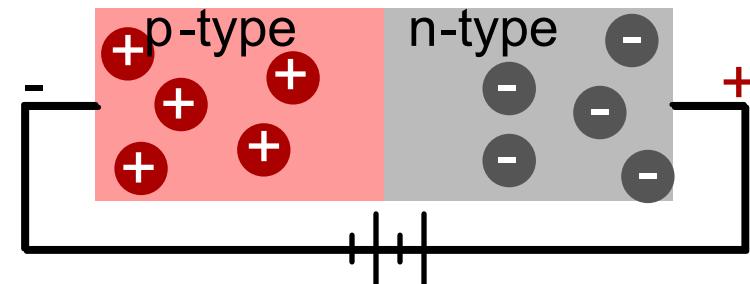
--No applied potential:
no net current flow.



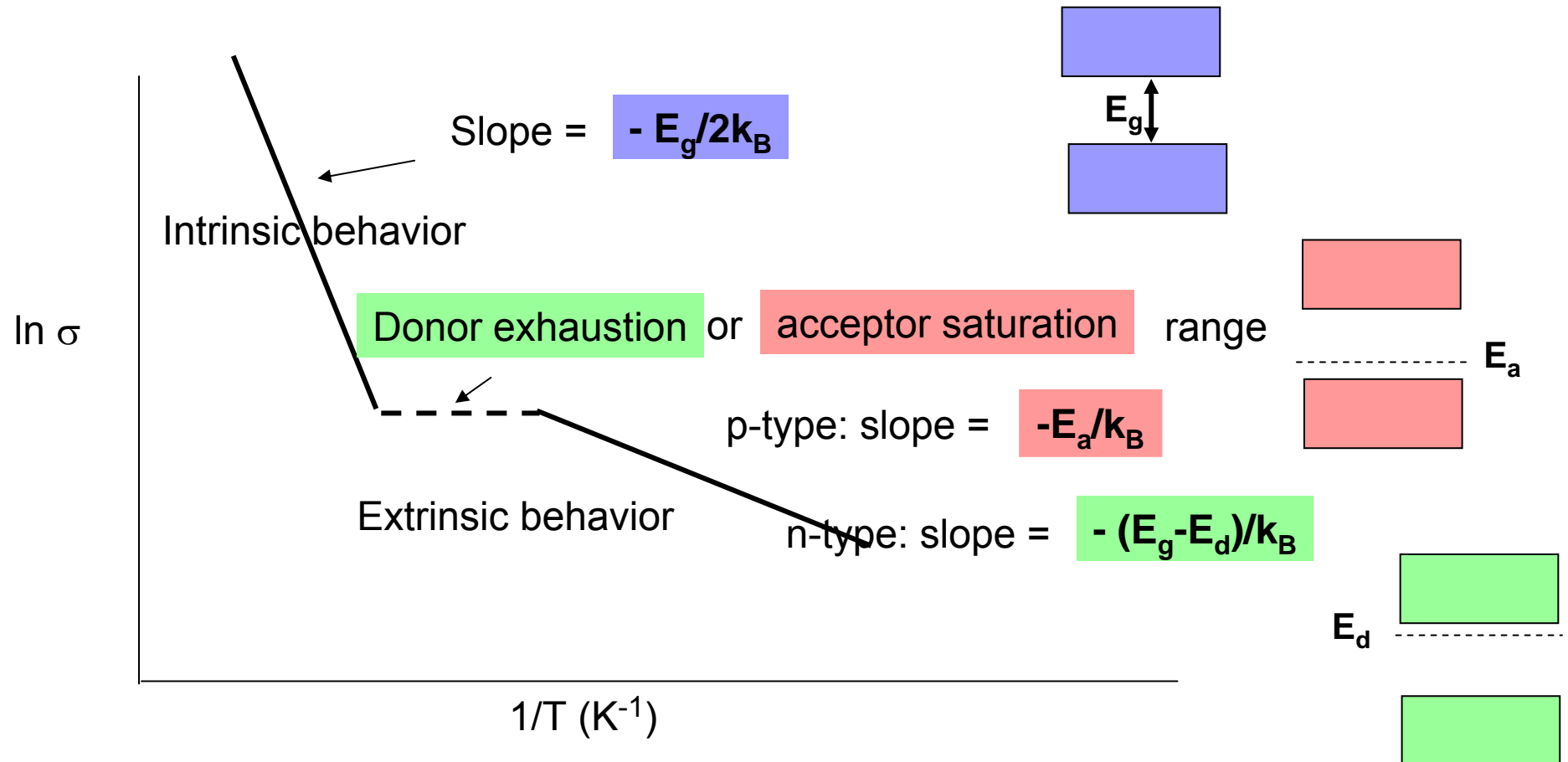
--Forward bias: carrier
flow through p-type and
n-type regions; holes and
electrons recombine at
p-n junction; current flows.



--Reverse bias: carrier
flow away from p-n junction;
carrier conc. greatly reduced
at junction; little current flow.

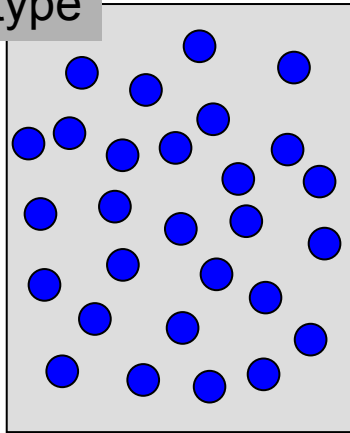


Extrinsic – Intrinsic temperature behavior

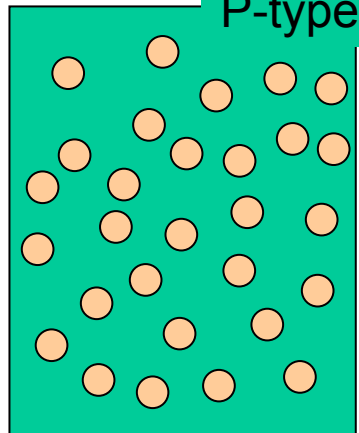


Silicon solar cell, $E_g = 1.1 \text{ eV}$

N-type



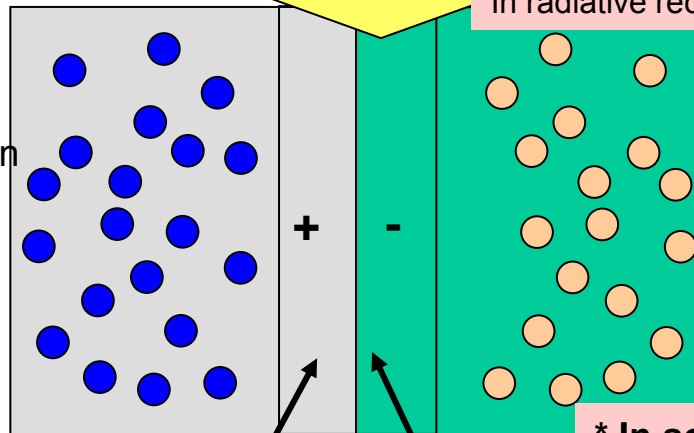
P-type



On contact electrons and holes neutralize each other in A thin layer recombination zone

Electron + hole = $h\nu$
In radiative recombination*

Charge separation creates electric field



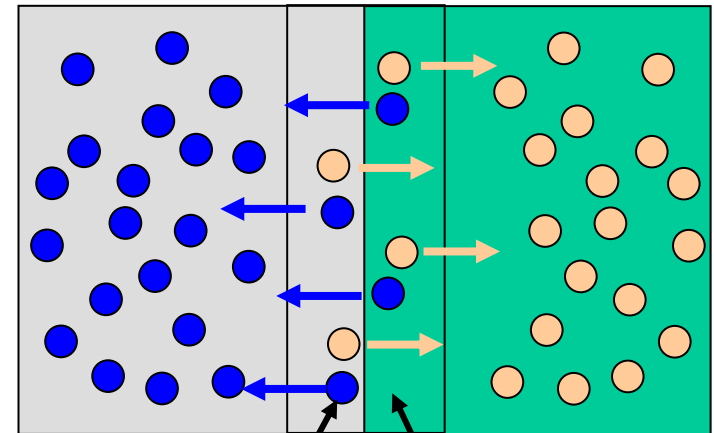
Positively charged layer

Negatively charged layer

* In some materials, such as GaAs, GaN light is given off

$h\nu = \text{Electron} + \text{hole}$

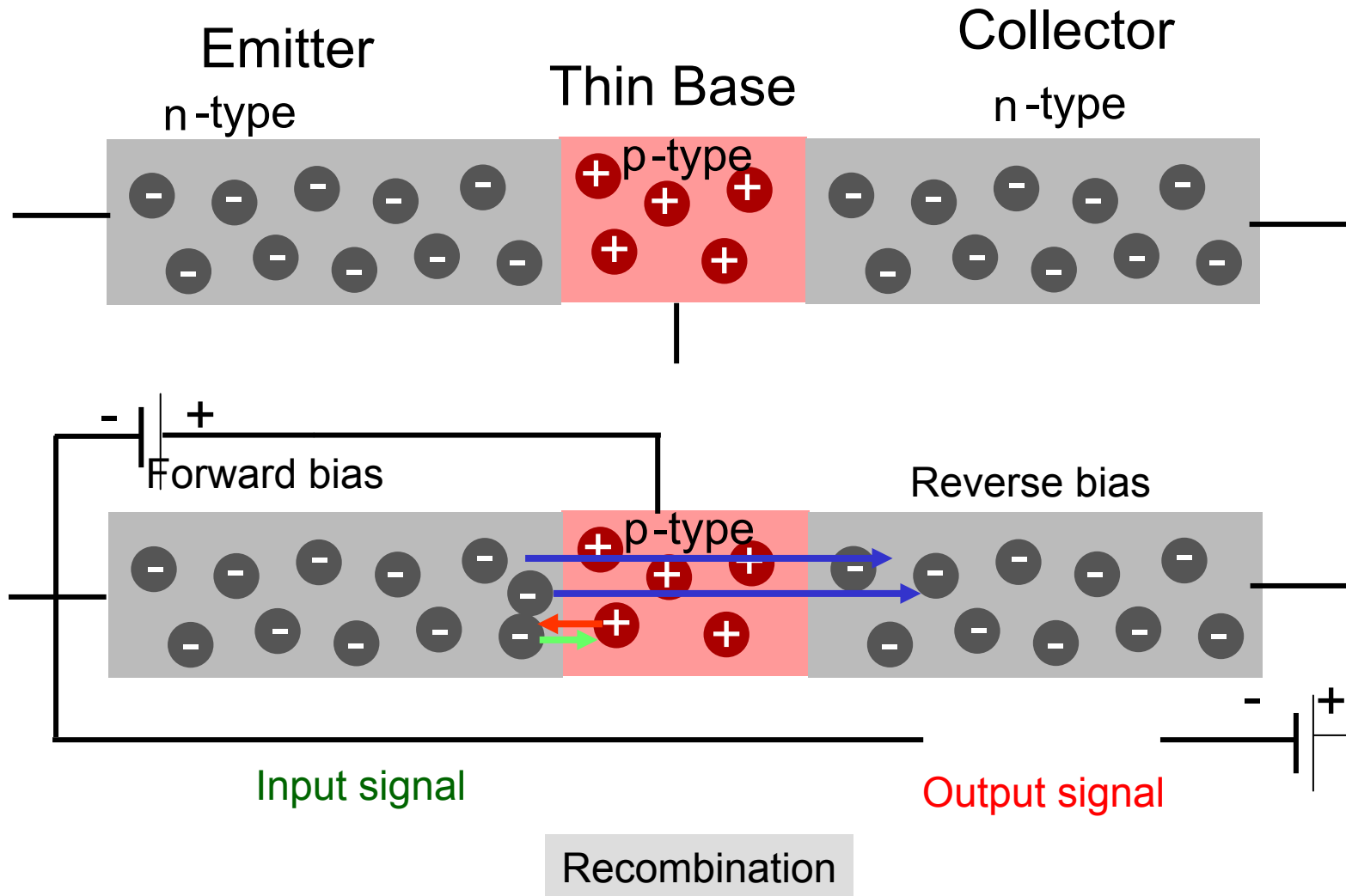
Incident light creates electron-hole pairs, which are moved as shown producing electricity



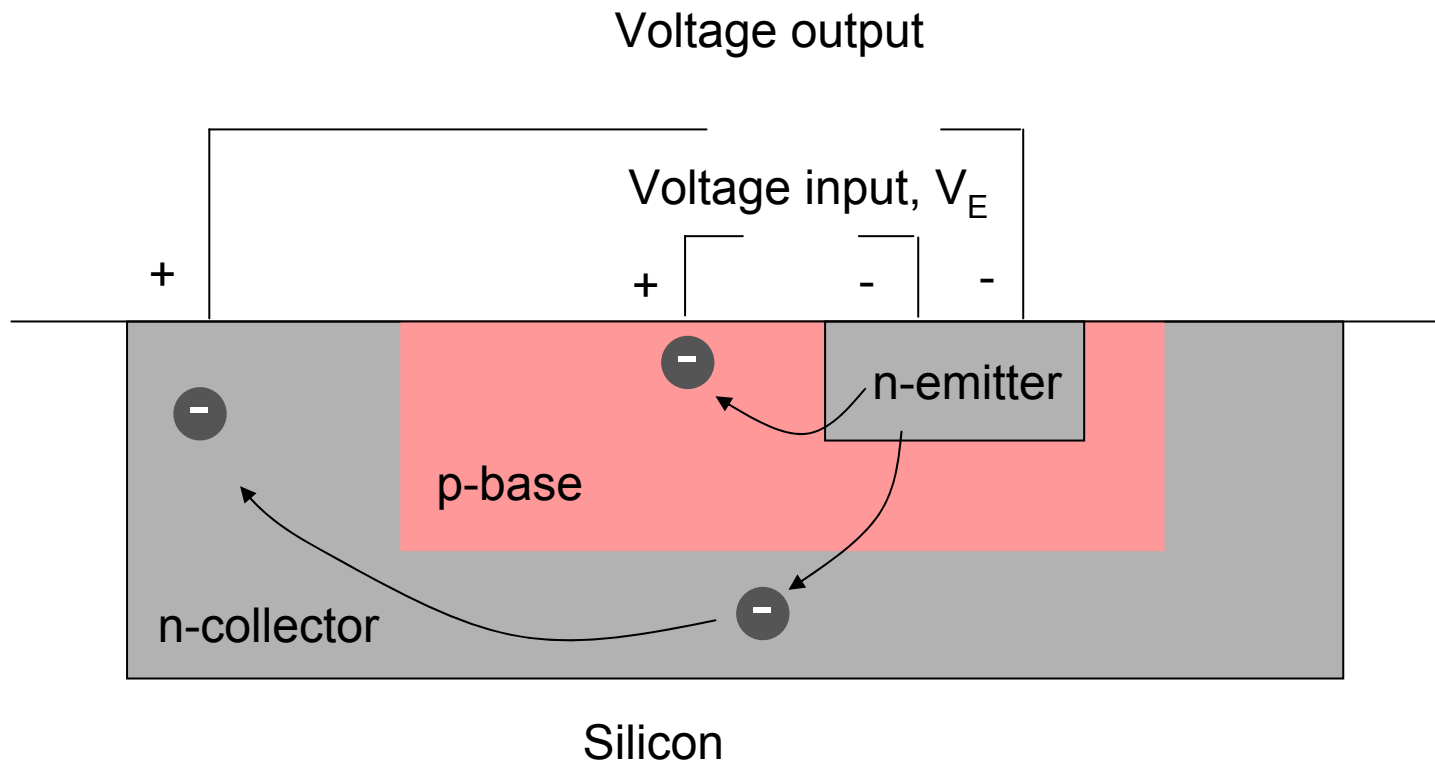
Positively charged layer

Negatively charged layer

Transistors

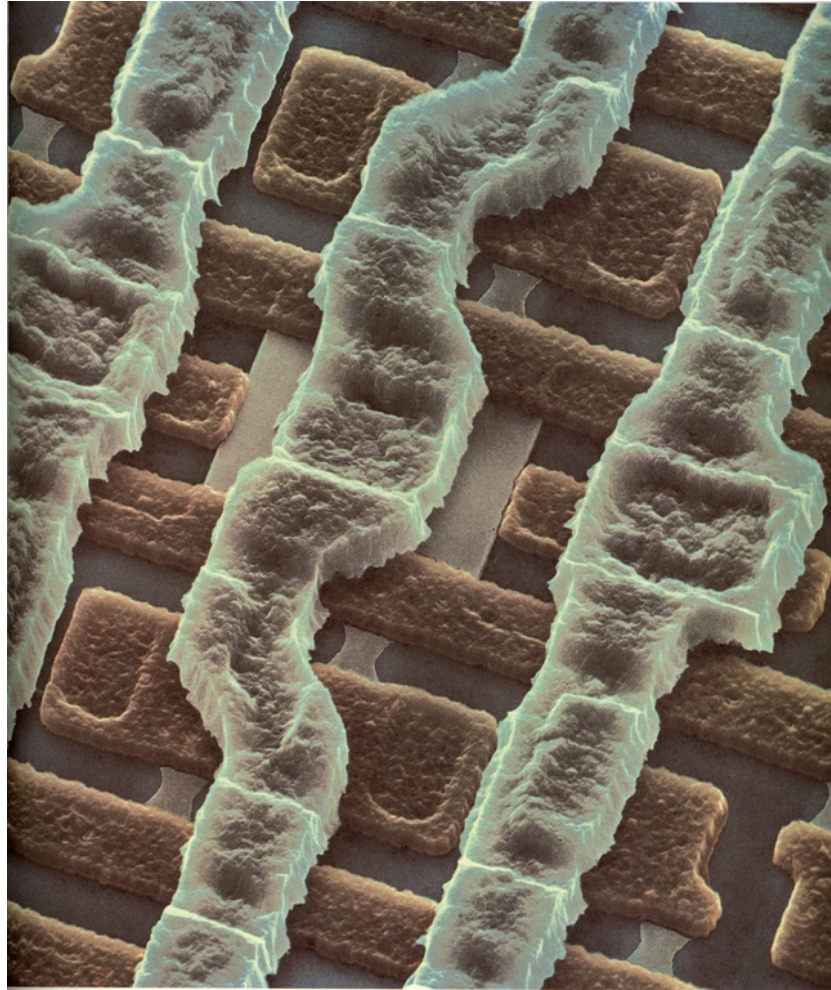


Bipolar junction transistor



SUMMARY

- Electrical **conductivity** and **resistivity** are:
 - material parameters.
 - geometry independent.
- Electrical **resistance** is:
 - a geometry and material dependent parameter.
- Conductors, semiconductors, and insulators...
 - different in whether there are accessible energy states for conductance electrons.
- For metals, conductivity is increased by
 - reducing deformation
 - reducing imperfections
 - decreasing temperature.
- For pure semiconductors, conductivity is increased by
 - increasing temperature
 - doping (e.g., adding B to Si (p-type) or P to Si (n-type)).



ANNOUNCEMENTS

Reading: Chapter 18 1-13

Core Problems: Chapter 18: 7, 12, 29,

Self-help Problems: Design Example 18.1